



Product Change Notification

Change Notification #: 117485 - 00
Change Title: Select Intel® SSD D3-S4510 Series,
PCN 117485-00, Manufacturing Site,
Add second manufacturing site
Date of Publication: May 8, 2020

Key Characteristics of the Change:

Manufacturing Site

Forecasted Key Milestones:

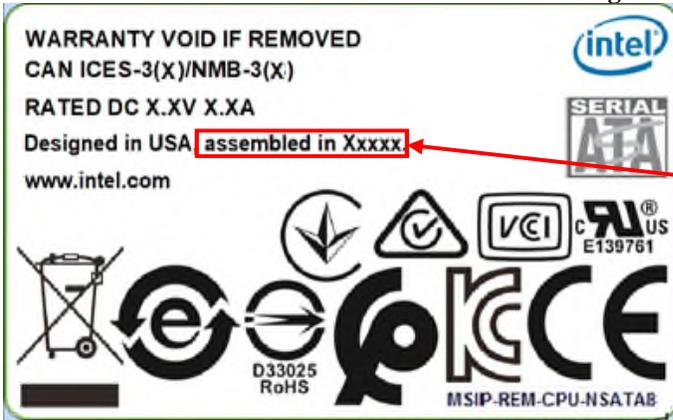
Date Customer Must be Ready to Receive Post-Conversion Material:	June 8, 2020
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Description of Change to the Customer:

Intel® SSD D3-S4510 Series SKUs listed in the products affected table will have the following changes:

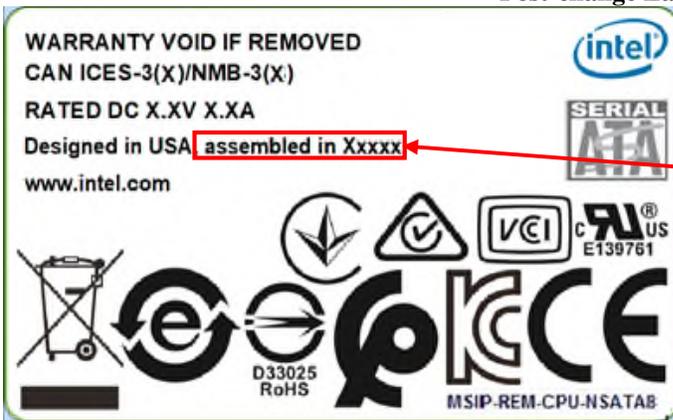
- Intel is enabling China as a second manufacturing site to ensure continuous supply.
- Along with this second manufacturing site the product labels will be updated with the Country of Origin (COO).

Pre-change Label:



Pre-change:
assembled in Taiwan

Post-change Label:



To be:
assembled in China or
assembled in Taiwan

Customer Impact of Change and Recommended Action:

The manufacturing site addition will have no impact to the functionality or quality of the product since Intel use a copy exact process and all material and process are the same at all manufacturing sites.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#
Intel® SSD D3-S4510 Series (240GB, M.2 80mm SATA 6Gb/s, 3D2, TLC) Generic Single Pack	SSDSCKKB240G801	963510
Intel® SSD D3-S4510 Series (480GB, M.2 80mm SATA 6Gb/s, 3D2, TLC) Generic Single Pack	SSDSCKKB480G801	963511
Intel® SSD D3-S4510 Series (960GB, M.2 80mm SATA 6Gb/s, 3D2, TLC) Generic Single Pack	SSDSCKKB960G801	963512
Intel® SSD D3-S4510 Series (240GB, M.2 80mm SATA 6Gb/s, 3D2, TLC) Generic 50 Pack	SSDSCKKB240G8	963514
Intel® SSD D3-S4510 Series (480GB, M.2 80mm SATA 6Gb/s, 3D2, TLC) Generic 50 Pack	SSDSCKKB480G8	963515
Intel® SSD D3-S4510 Series (960GB, M.2 80mm SATA 6Gb/s, 3D2, TLC) Generic 50 Pack	SSDSCKKB960G8	963516

PCN Revision History:

Date of Revision:

May 8, 2020

Revision Number:

00

Reason:

Originally Published PCN



Product Change Notification

117485 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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